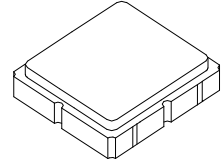




- *RF Filter for Wimax Application*
- *3.0 x 3.0mm Surface Mount Case*
- *50Ω Input / Output Impedance*

SF2126E

725.00 MHz SAW Filter



SM3030-8

Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	15	dBm
DC Voltage	3	V
Operating Temperature Range	-30 to +85	°C
Storage Temperature Range	-40 to +85	°C

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	F_C			725		MHz
Frequency Range			700		750	MHz
Insertion Loss	IL			2.6	3.0	dB
Ripple 700 - 750 MHz				1	1.5	
VSWR					2.2	
Attenuation (absolute) 500 - 600 MHz			40			
601 - 650 MHz			30			
651 - 665 MHz			20			
780 - 824 MHz			15			
825 - 844 MHz			30			
845 - 960 MHz			40			
Source Impedance	Z_S			50		Ω
Load Impedance	Z_L			50		Ω

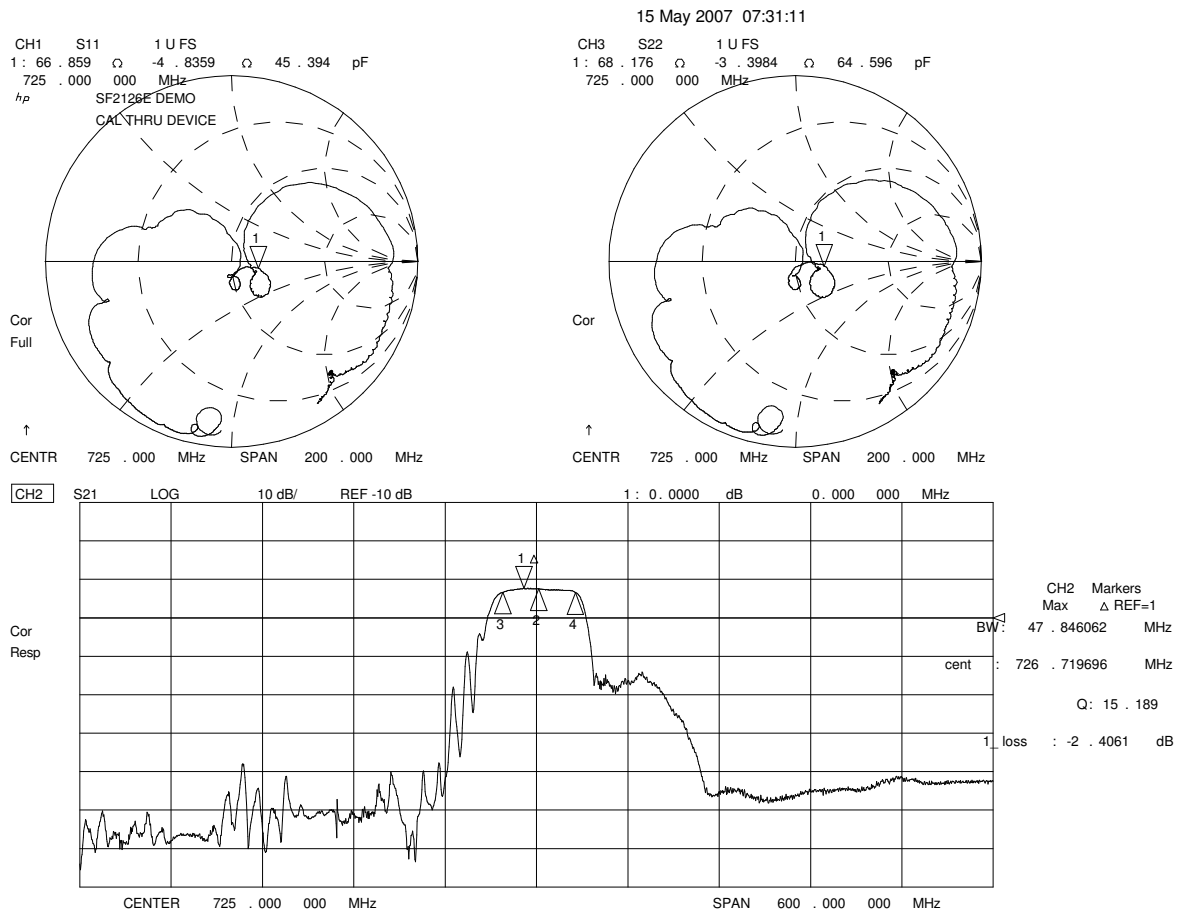
Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	648, YWWS
Standard Reel Quantity Reel Size 7 Inch	1000 Pieces/Reel
Reel Size 13 Inch	3000 Pieces/Reel

Notes:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, f_c .
3. The design, manufacturing process, and specifications of this filter are subject to change.
4. US and international patents may apply.
5. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
6. ©Copyright 1999, RF Monolithics Inc.
7. Electrostatic Sensitive Device. Observe precautions for handling.



Frequency Characteristics:



See Detail "A"

100 REF.

"B" REF.

12.0

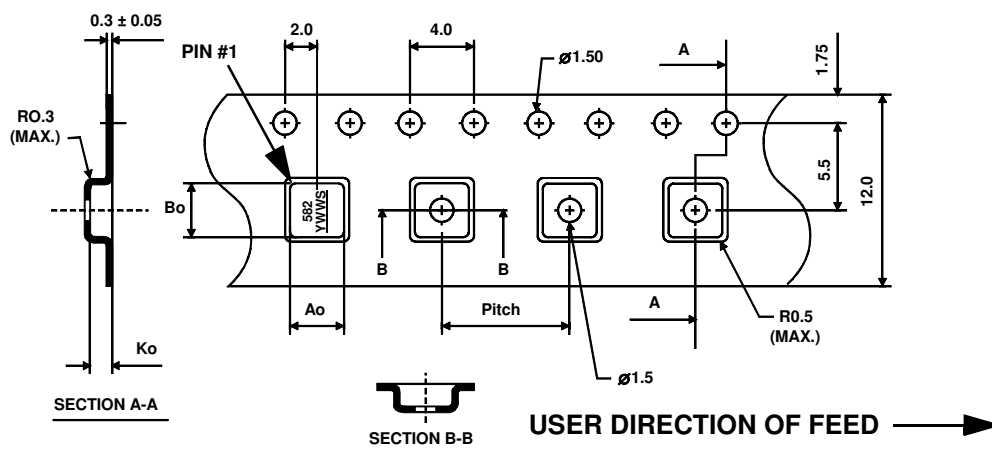
13.0

20.2

2.0

“B” Nominal Size	
Inches	millimeters
7	178
13	330

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm

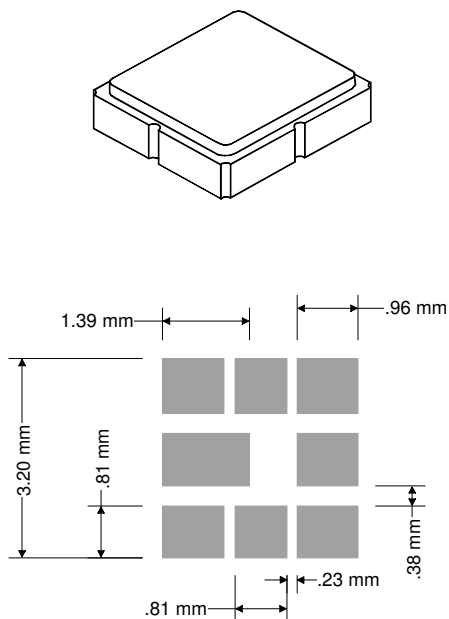


SM3030-8 Case

8-Terminal Ceramic Surface-Mount Case
3.0 X 3.0 mm Nominal Footprint

Case Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.0	3.13	0.113	0.118	0.123
B	2.87	3.0	3.13	0.113	0.118	0.123
C	1.14	1.27	1.40	0.045	0.050	0.055
D	0.79	0.92	1.05	0.031	0.036	0.041
E	0.62	0.75	0.88	0.024	0.029	0.034
F	0.47	0.60	0.73	0.018	0.024	0.029
G	0.47	0.60	0.73	0.018	0.024	0.029
H	1.07	1.20	1.33	0.042	0.047	0.052



Foot Print Dimensions

Electrical Connections

	Connection	Terminals
	Input	1
	Output	5
	Ground	All Others
Dot Indicates Pin 1		

Materials

Solder Pad Termination	Au plating 30 - 60 μ inches (76.2-152 μ m) over 80-200 μ inches (203-508 μ m) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 μ inches Thick
Body	Al ₂ O ₃ Ceramic
Pb Free	

TOP VIEW

BOTTOM VIEW

